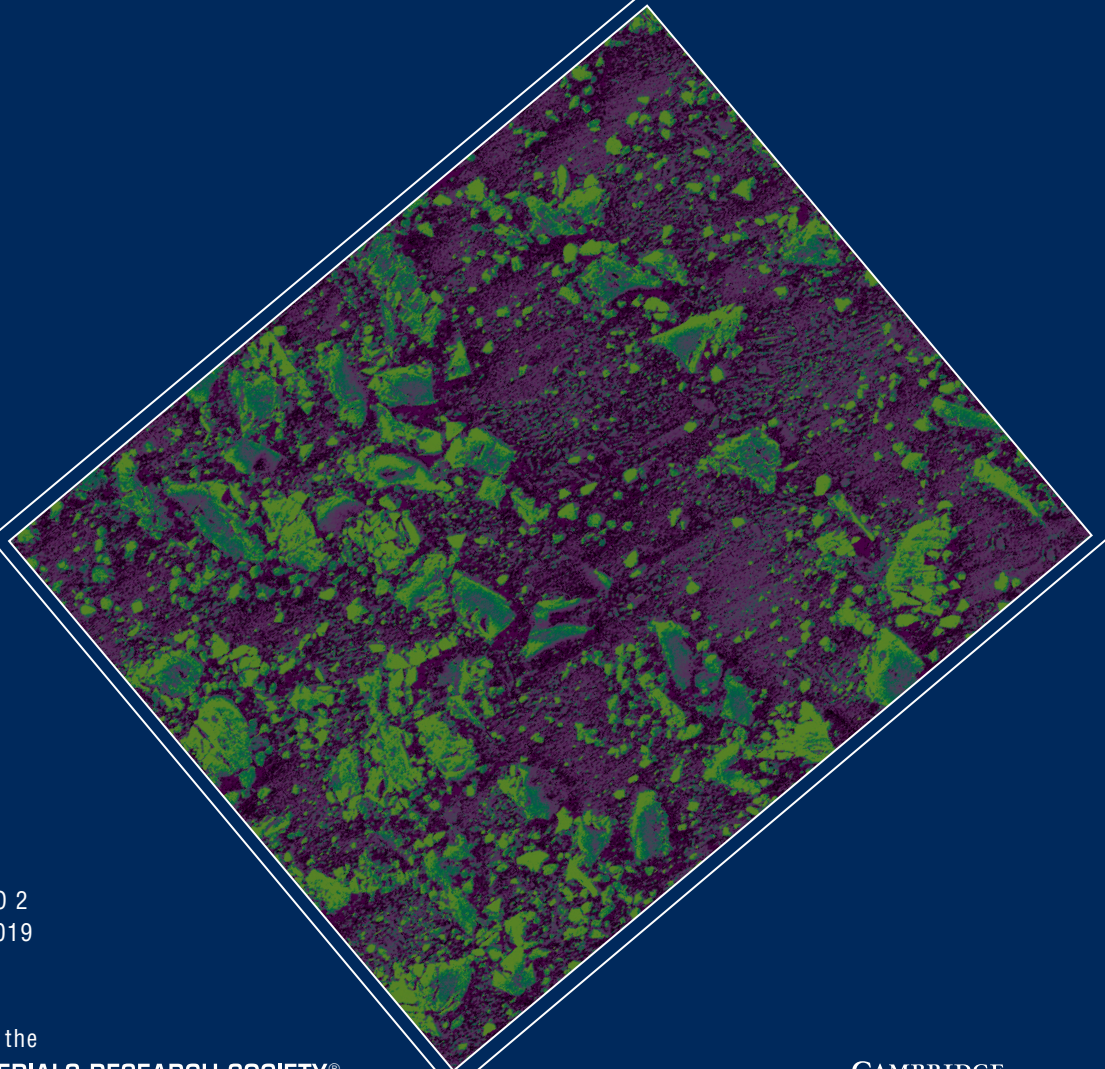




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Cover: The global SEM microstructure of the extruded composite aging after different time. [H. Chang, X. Hu, X. Wang, J. Du, L. Tong: Aging behavior of the extruded SiCp- reinforced AZ91 Mg alloy composite. p. 335].

Journal of MATERIALS RESEARCH

Volume 34, Number 2, January 28, 2019

ARTICLES

- 231–239 **Chitosan/hollow silica sphere nanocomposites for wound healing application** Ayşe Aslan, Silviya Elanthikkal, Ayhan Bozkurt
- 240–250 **Study of growth advantage of twinned dendrites in aluminum alloys during Bridgman solidification** Luyan Yang, Shuangming Li, Yang Li, Kai Fan, Hong Zhong
- 251–260 **Formation of low-angle grain boundaries under different solidification conditions in the rejoined platforms of Ni-based single crystal superalloys** Miao Huo, Lin Liu, Wenchao Yang, Yafeng Li, Songsong Hu, Haijun Su, Jun Zhang, Hengzhi Fu

INVITED PAPER

- 261–270 **Interplay of slip and twinning in niobium single crystals compressed at 77 K** Roman Gröger, Zdeněk Chlup, Tereza Kuběnová, Ivo Kuběna

ARTICLES

- 271–281 **Quantitative understanding of the effect of grain rotation on the nanovoid growth** Xudong Li, Jianqiu Zhou
- 282–289 **On the behaviors of porous shape memory alloy beam with gradient porosity under pure bending** Yanan Zhang, Bingfei Liu, Chunzhi Du, Rui Zhou
- 290–300 **Effect of Zr additions on crystal structures and mechanical properties of binary W–Zr alloys: A first-principles study** Jiang Diyou, Xue Li, Huang Xuemei, Wang Tao, Hu Jianfeng
- 301–308 **Microstructure and oxidation behavior of the CrMoNbTaV high-entropy alloy** Yifeng Xiao, Wenhui Kuang, Yanfei Xu, Liang Wu, Wenjuan Gong, Jinwen Qian, Qiankun Zhang, Yuehui He
- 309–320 **Influence of the deformation heating on the flow behavior of 6063 alloy during compression at medium strain rates** Shikang Li, Luoxing Li, Hong He, Guan Wang
- 321–334 **EBSDB study of strain dependent microstructure evolution during hot deformation of a typical nickel-based superalloy** Hongbin Zhang, Shengxue Qin, Huiping Li, Jie Liu, Yuting Lv, Yan Wang, Peng Zhang, Haiping Zhou, Tao Wu
- 335–343 **Aging behavior of the extruded SiCp-reinforced AZ91 Mg alloy composite** Hai Chang, Xiaoshi Hu, Xiaojun Wang, Junfeng Du, Libo Tong
- 344–353 **Microstructures and mechanical properties of Ti/Al/Mg/Al/Ti laminates with various rolling reductions** Taolue Wang, Huihui Nie, Yujie Mi, Xinwei Hao, Fan Yang, Chengzhong Chi, Wei Liang

CORRIGENDUM

- 354 **Development of ultrafine grained Al 7075 by cryogenic temperature large strain extrusion machining – CORRIGENDUM** Xiaolong Yin, Yunyun Pi, Di He, Jiayang Zhang, Wenjun Deng

(Continued)

355

**Effect of electropulsing-ultrasonic surface treatment on the surface properties and the corrosion behavior of 45 steel—
CORRIGENDUM**

Bing Zhang, Haibo Wang,
Shuo Zhang, Guolin Song,
Song-Zhu Kure-Chu,
Xinglong Wang, Jie Kuang,
Guoyi Tang